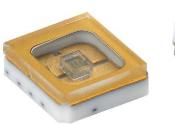


UVC Emitting Diode in SMD Package





DESCRIPTION

VLMU35CM..-280-120 is a ceramic based mid power UVC LED with quartz window for long life time. The package size is 3.5 mm x 3.5 mm x 1.2 mm and the radiant power typically 15 mW at 100 mA in a wavelength range of 265 nm to 285 nm.

PRODUCT GROUP AND PACKAGE DATA

Product group: LEDPackage: SMD ceramic

Product series: standard power UV LED

• Angle of half intensity: ± 60°

· Lead-finishing: Au

FEATURES

- Ceramic SMT package with quartz window
- Dimension (L x W x H) in mm: 3.5 x 3.5 x 1.2
- Forward current: up to 150 mA
- Radiant power (typ.): 15 mW at 100 mA
- Leads / terminations finish: gold plated (Au)
- · Reflow soldering method
- MSL 3 according to J-STD-020
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912





ROHS COMPLIANT HALOGEN FREE

GREEN (5-2008)

APPLICATIONS

- Sterilization
- Medical application
- Sensing of gases, germs, DNA, ...

SAFETY ADVICES

Depending on the mode of operation, these devices emit highly concentrated non visible ultraviolet light which can be hazardous to the human eye and skin. Products which incorporate these devices have to follow the safety precautions given in IEC 62471 "Photobiological Safety of Lamps and Lamp Systems".

PARTS TABLE														
PART	COLOR	RADIANT POWER (mW)		at I _F	WAVELENGTH (nm)		at I _F	FORWARD VOLTAGE (V)		at I _F	TECHNOLOGY			
		MIN.	TYP.	MAX.	(mA)	MIN.	TYP.	MAX.	(mA)	MIN.	TYP.	MAX.	(mA)	
VLMU35CM00-280-120	Ultraviolet	8	15	-	100	265	278	285	100	4	5	7	100	AlGaN

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) VLMU35CM280-120							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
DC forward current		I _F	150	mA			
Power dissipation		P _V	0.86	W			
Reverse voltage	Not designed for reverse operation						
Electrostatic discharge	HBM: MIL-STD-883 C 3B	ESD	2000	V			
Junction temperature		Tj	+85	°C			
Operating temperature range		T _{amb}	-40 to +80	°C			
Storage temperature range		T _{stg}	-40 to +100	°C			
Solder temperature		T _{sol}	260	°C			



OPTICAL AND ELECTRICAL CHARACTERISTICS ($T_{amb} = 25$ °C, unless otherwise specified) VLMU35CM280-120, ULTRAVIOLET							
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Forward voltage	I _F = 100 mA	V _F	4	5	7	V	
Radiant power	I _F = 100 mA	фe	8	15	-	mW	
Ratio of radiant intensity/radiant power	I _F = 100 mA	l _e /φ _e	-	0.28	-	sr ⁻¹	
Peak wavelength	I _F = 100 mA	λ_{p}	265	278	285	nm	
Angle of half intensity	I _F = 100 mA	φ	-	± 60	-	0	
Thermal resistance junction to solder pin		R _{thJS}	-	15	-	K/W	
Thermal resistance junction to ambient	Soldered on 20 x 20 x 1.7 (in mm) Al MCPCB	R _{thJA}	-	30	-	K/W	

Note

• Tolerances: \pm 11 % for $\varphi_e,\,\pm$ 0.1 V for $V_F,\,\pm$ 3 nm for λ_p

RADIANT POWER CLASSIFICATION (I _F = 100 mA)						
GROUP	MIN.	MAX.	UNIT			
X3	8	10				
X4	10	12				
X5	12	14				
X6	14	16	mW			
X7	16	18				
X8	18	20				
Х9	20	22				

PEAK WAVELENGTH CLASSIFICATION (I _F = 100 mA)							
GROUP MIN. MAX. UNIT							
W1 265 285 nm							

FORWARD VOLTAGE CLASSIFICATION (I _F = 100 mA)						
GROUP MIN. MAX. UNIT						
VX	4	5				
VY	5	6	V			
VO	6	7				

Note

In order to ensure availability, single groups for radiant intensity, wavelength, and forward voltage will not be orderable. Only one group for
radiant intensity, wavelength, and forward voltage will be shipped in any one reel

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

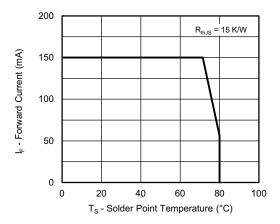


Fig. 1 - Maximum Forward Current vs. Solder Point Temperature

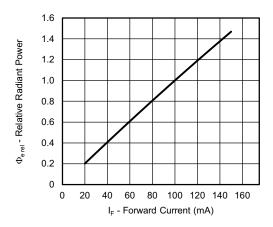


Fig. 2 - Relative Radiant Power vs. Forward Current

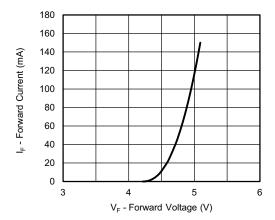


Fig. 3 - Forward Current vs. Forward Voltage

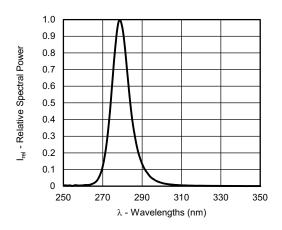


Fig. 4 - Relative Spectral Power vs. Wavelength

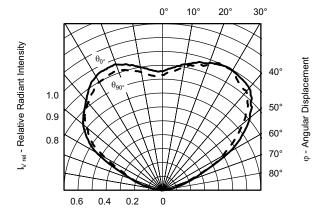


Fig. 5 - Relative Radiant Intensity vs. Angular Displacement

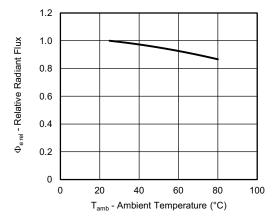
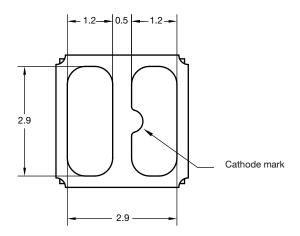
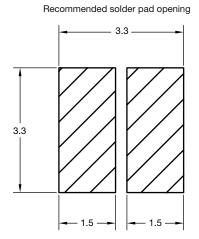


Fig. 6 - Relative Radiant Flux vs. Ambient Temperature

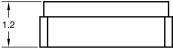


PACKAGE DIMENSIONS in millimeters

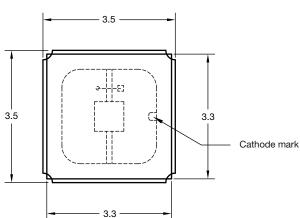




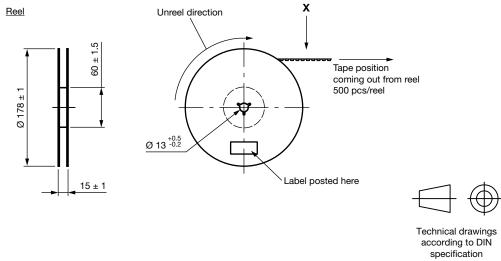
Ciruit diagram



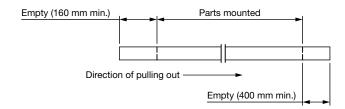


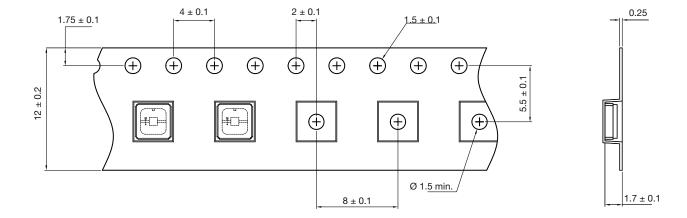


TAPE AND REEL DIMENSIONS in millimeters



Leader and trailer tape





SOLDERING PROFILE

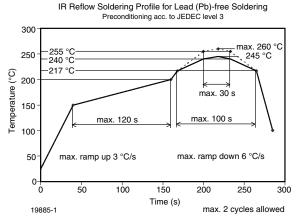
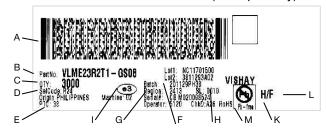


Fig. 7 - Vishay Lead (Pb)-free Reflow Soldering Profile (according to J-STD-020C)

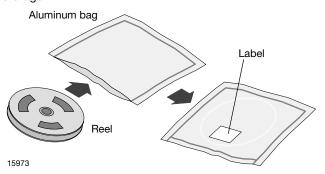
BAR CODE PRODUCT LABEL (example only)



- a. 2D barcode
- b. Vishay part number
- c. Quantity
- d. SEL = selection code (binning)
- e. Code of manufacturing plant
- f. Batch = date code: year / week / plant code
- g. Region code
- h. SL = sales location
- i. Terminations finishing
- j. Lead (Pb)-free symbol
- k. Halogen-free symbol
- I. RoHS symbol

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

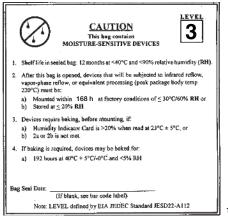
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

24 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard JESD22-A112 level 3 label is included on all dry bags.



17028-2

Example of JESD22-A112 level 3 label

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



Legal Disclaimer Notice

Vishay

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